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## **ANSMITTAL OF FORMAL DRAWINGS**

Docket No. 51959 (ACT-173)

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ln	Re Am	lication	Of:

M. Dautartas et al.

Serial No.	Filing Date	Confirmation No.	Examiner	Art Unit
10/013,084	12/10/2001	1473	Daniel J. Petkovsek	2874

Invention:

OPTICAL DEVICE PACKAGE FOR FLIP-CHIP MOUNTING

Address to:

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Transmitted herewith are:

7 sheets of formal drawing(s) for this application.

Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).

FEB 13 2004 TECHNOLOGY CENTER 2800

Signature

Jonathan D. Baskin (Reg. No. 39,499)

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Dated:

01/30/2004

I certify that this document and attached formal drawings are being deposited on 01/30/2004 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8

U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature of Person Mailing Correspondence

Deanna M. Rivernider

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